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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

### Applications of "[Embedded - Microcontrollers](#)"

#### Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	64MHz
Connectivity	I <sup>2</sup> C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, HLVD, POR, PWM, WDT
Number of I/O	25
Program Memory Size	16KB (8K x 16)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 24x12b; D/A 1x5b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SSOP (0.209", 5.30mm Width)
Supplier Device Package	28-SSOP
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/pic18lf24k42-e-ss">https://www.e-xfl.com/product-detail/microchip-technology/pic18lf24k42-e-ss</a>

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# PIC18(L)F24/25K42

**TABLE 1-1: DEVICE FEATURES**

Features	PIC18(L)F24K42	PIC18(L)F25K42
Program Memory (Bytes)	16384	32768
Program Memory (Instructions)	8192	16384
Data Memory (Bytes)	1024	2048
Data EEPROM Memory (Bytes)	256	256
I/O Ports	A,B,C,E <sup>(1)</sup>	A,B,C,E <sup>(1)</sup>
Capture/Compare/PWM Modules (CCP)	4	4
10-Bit Pulse-Width Modulator (PWM)	4	4
12-Bit Analog-to-Digital Module (ADC <sup>2</sup> ) with Computation Accelerator	5 internal 24 external	5 internal 24 external
Packages	28-pin SPDIP 28-pin SOIC 28-pin SSOP 28-pin QFN 28-pin UQFN	28-pin SPDIP 28-pin SOIC 28-pin SSOP 28-pin QFN 28-pin UQFN
Timers (16-/8-bit)	4/3	
Serial Communications	2 UART, 2 I <sup>2</sup> C, 1 SPI	
Enhanced Complementary Waveform Generator (ECWG)	3	
Zero-Cross Detect (ZCD)	1	
Data Signal Modulator (DSM)	1	
Signal Measurement Timer (SMT)	1	
5-Bit Digital-to-Analog Converter (DAC)	1	
Numerically Controlled Oscillator (NCO)	1	
Comparator Module	2	
Direct Memory Access (DMA)	2	
Configurable Logic Cell (CLC)	4	
Peripheral Pin Select (PPS)	Yes	
Peripheral Module Disable (PMD)	Yes	
16-bit CRC with Scanner	Yes	
Programmable High/Low-Voltage Detect (HLVD)	Yes	
Programmable Brown-out Reset (BOR)	Yes	
Resets (and Delays)	POR, BOR, RESET Instruction, Stack Overflow, Stack Underflow (PWRT, OST), MCLR, WDT, Memory Execution Violation	
Instruction Set	81 Instructions; 87 with Extended Instruction Set enabled	
Operating Frequency	64 MHz	

**Note 1:** PORTE contains the single RE3 input-only pin.

## 7.0 DEVICE CONFIGURATION INFORMATION

The Device Configuration Information (DCI) is a dedicated region in the Program memory space mapped from 3FFF00h to 3FFF09h. The data stored in these locations is read-only and cannot be erased or modified.

Refer to [Table 7-1: Device Configuration Information](#) for the complete DCI table address and description. The DCI holds information about the device which is useful for programming and Bootloader applications. These locations are read-only and cannot be erased or modified.

**TABLE 7-1: DEVICE CONFIGURATION INFORMATION**

ADDRESS	Name	DESCRIPTION	VALUE	UNITS
3FFF00h-3FFF01h	ERSIZ	Erase Row Size	32	Words
3FFF02h-3FFF03h	WLSIZ	Number of write latches	64	
3FFF04h-3FFF05h	URSIZ	Number of User Rows	See <a href="#">Table 7-2</a>	Rows
3FFF06h-3FFF07h	EESIZ	EE Data memory size	256	Bytes
3FFF08h-3FFF09h	PCNT	Pin Count	28	Pins

**TABLE 7-2: MEMORY SIZE AND NUMBER OF USER ROWS**

Part Name	Memory size	Number of user rows
PIC18(L)F24K42	8K	256
PIC18(L)F25K42	16K	512

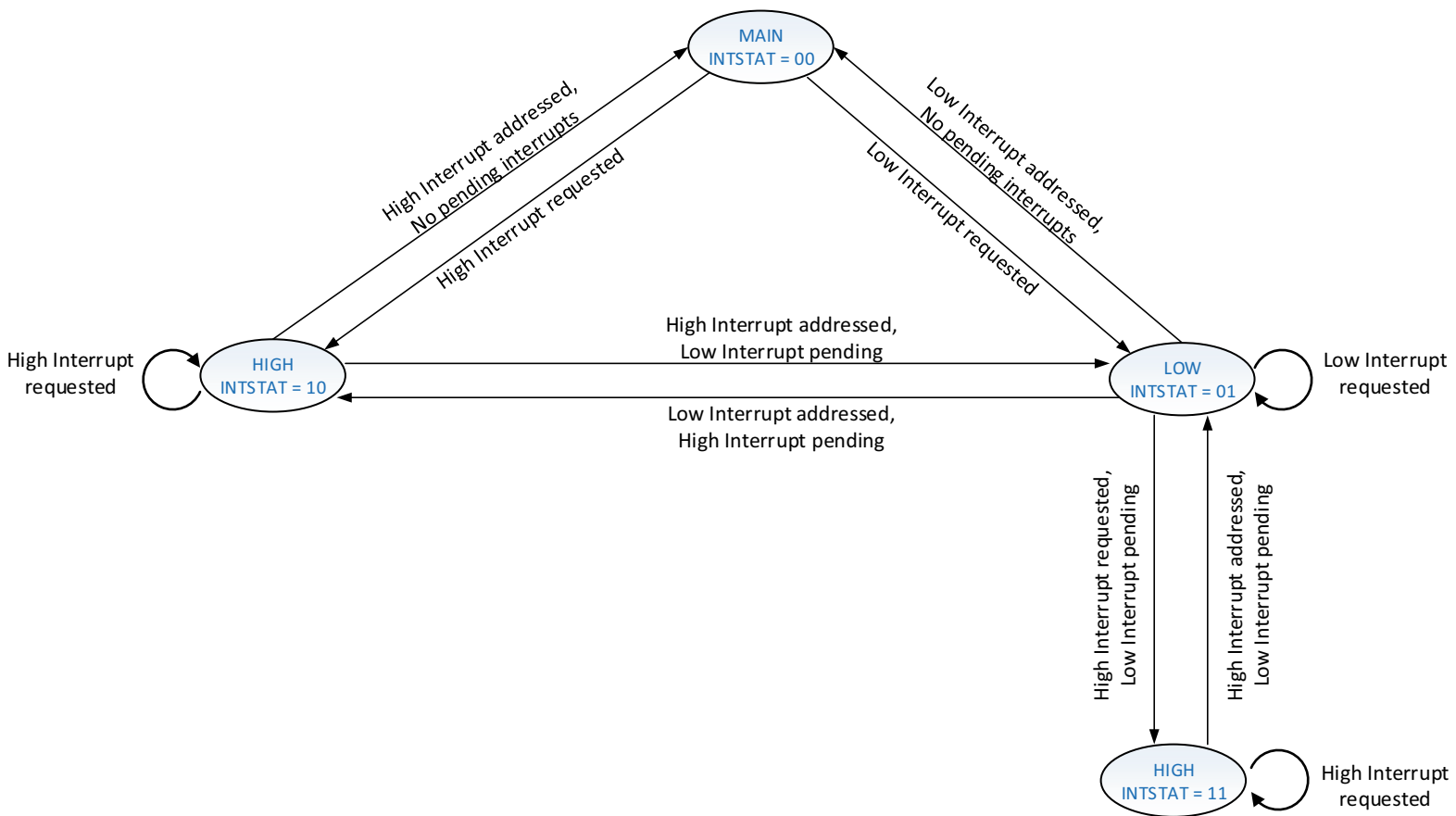
### 7.1 DIA and DCI Access

The DIA and DCI addresses are read-only and cannot be erased or modified. See [Section 15.2 “Device Information Area, Device Configuration Area, User ID, Device ID and Configuration Word Access”](#) for more information on accessing these memory locations.

Development tools, such as device programmers and debuggers, may be used to read the DIA and DCI regions, similar to the Device ID and Revision ID.

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FIGURE 11-1: VECTORED INTERRUPTS STATE TRANSITION DIAGRAM



## 15.1.4 NVM UNLOCK SEQUENCE

The unlock sequence is a mechanism that protects the NVM from unintended self-write programming or erasing. The sequence must be executed and completed without interruption to successfully complete any of the following operations:

- PFM Row Erase
- Write of PFM write latches to PFM memory
- Write of PFM write latches to User IDs
- Write to Data EEPROM Memory
- Write to Configuration Words

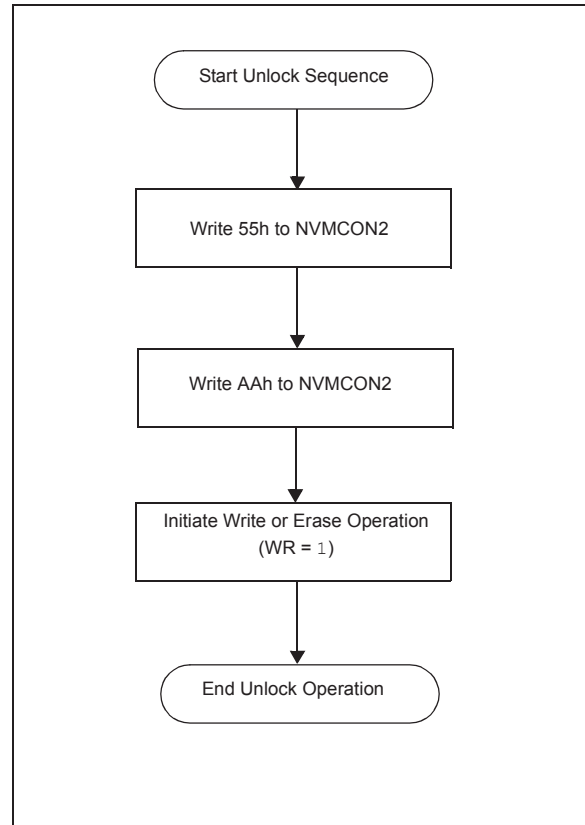
The unlock sequence consists of the following steps and must be completed in order:

- Write 55h to NVMCON2
- Write AAh to NVMCON2
- Set the WR bit of NVMCON1

Once the WR bit is set, the processor will stall internal operations until the operation is complete and then resume with the next instruction.

Since the unlock sequence must not be interrupted, global interrupts should be disabled prior to the unlock sequence and re-enabled after the unlock sequence is completed.

**FIGURE 15-6: NVM UNLOCK SEQUENCE FLOWCHART**



### EXAMPLE 15-2: NVM UNLOCK SEQUENCE

BCF	INTCON0,GIE	; Recommended so sequence is not interrupted
BANKSEL	NVMCON1	
BSF	NVMCON1,WREN	; Enable write/erase
MOVLW	55h	; Load 55h
MOVWF	NVMCON2	; Step 1: Load 55h into NVMCON2
MOVLW	AAh	; Step 2: Load W with AAh
MOVWF	NVMCON2	; Step 3: Load AAh into NVMCON2
BSF	INTCON1,WR	; Step 4: Set WR bit to begin write/erase
BSF	INTCON0,GIE	; Re-enable interrupts

**Note 1:** Sequence begins when NVMCON2 is written; steps 1-4 must occur in the cycle-accurate order shown. If the timing of the steps 1 to 4 is corrupted by an interrupt or a debugger Halt, the action will not take place.

**2:** Opcodes shown are illustrative; any instruction that has the indicated effect may be used.

## 16.8 Scanner Module Overview

The Scanner allows segments of the Program Flash Memory or Data EEPROM, to be read out (scanned) to the CRC Peripheral. The Scanner module interacts with the CRC module and supplies it data one word at a time. Data is fetched from the address range defined by SCANLADR registers up to the SCANHADR registers.

The Scanner begins operation when the SGO bit is set (SCANCON0 Register) and ends when either SGO is cleared by the user or when SCANLADR increments past SCANHADR. The SGO bit is also cleared by clearing the EN bit (CRCCON0 register).

## 16.9 Configuring the Scanner

The scanner module may be used in conjunction with the CRC module to perform a CRC calculation over a range of program memory or Data EEPROM addresses. In order to set up the scanner to work with the CRC, perform the following steps:

1. Set up the CRC module (See [Section 16.7 “Configuring the CRC”](#)) and enable the Scanner module by setting the EN bit in the SCANCON0 register.
2. Choose which memory region the Scanner module should operate on and set the MREG bit of the SCANCON0 register appropriately.
3. If trigger is used for scanner operation, set the TRIGEN bit of the SCANCON0 register and select the trigger source using SCANTRIG register. Select the trigger source using SCANTRIG register and then set the TRIGEN bit of the SCANCON0 register. See [Table 16-2](#) for Scanner Operation.
4. If Burst mode of operation is desired, set the BURSTMD bit (SCANCON0 register). See [Table 16-2](#) for Scanner Operation.
5. Set the SCANLADRL/H/U and SCANHADRL/H/U registers with the beginning and ending locations in memory that are to be scanned.
6. Select the priority level for the Scanner module (See [Section 3.1 “System Arbitration”](#)) and lock the priorities (See [Section 3.1.1 “Priority Lock”](#)).
7. Both CRCEN and CRCGO bits must be enabled to use the scanner. Setting the SGO bit will start the scanner operation.

## 16.10 Scanner Interrupt

The scanner will trigger an interrupt when the SCANLADR increments past SCANHADR. The SCANIF bit can only be cleared in software.

## 16.11 Scanning Modes

The interaction of the scanner with the system operation is controlled by the priority selection in the System Arbiter (see [Section 3.2 “Memory Access Scheme”](#)). Additionally, BURSTMD and TRIGEN also determine the operation of the Scanner.

### 16.11.1 TRIGEN = 0, BURSTMD = 0

In this case, the memory access request is granted to the scanner if no other higher priority source is requesting access.

All sources with lower priority than the scanner will get the memory access cycles that are not utilized by the scanner.

### 16.11.2 TRIGEN = 1, BURSTMD = 0

In this case, the memory access request is generated when the CRC module is ready to accept.

The memory access request is granted to the scanner if no other higher priority source is requesting access. All sources with lower priority than the scanner will get the memory access cycles that are not utilized by the scanner.

The memory access request is granted to the scanner if no other higher priority source is requesting access. All sources with lower priority than the scanner will get the memory access cycles that are not utilized by the scanner.

### 16.11.3 TRIGEN = x, BURSTMD = 1

In this case, the memory access is always requested by the scanner.

The memory access request is granted to the scanner if no other higher priority source is requesting access. The memory access cycles will not be granted to lower priority sources than the scanner until it completes operation i.e. SGO = 0 (SCANCON0 register)

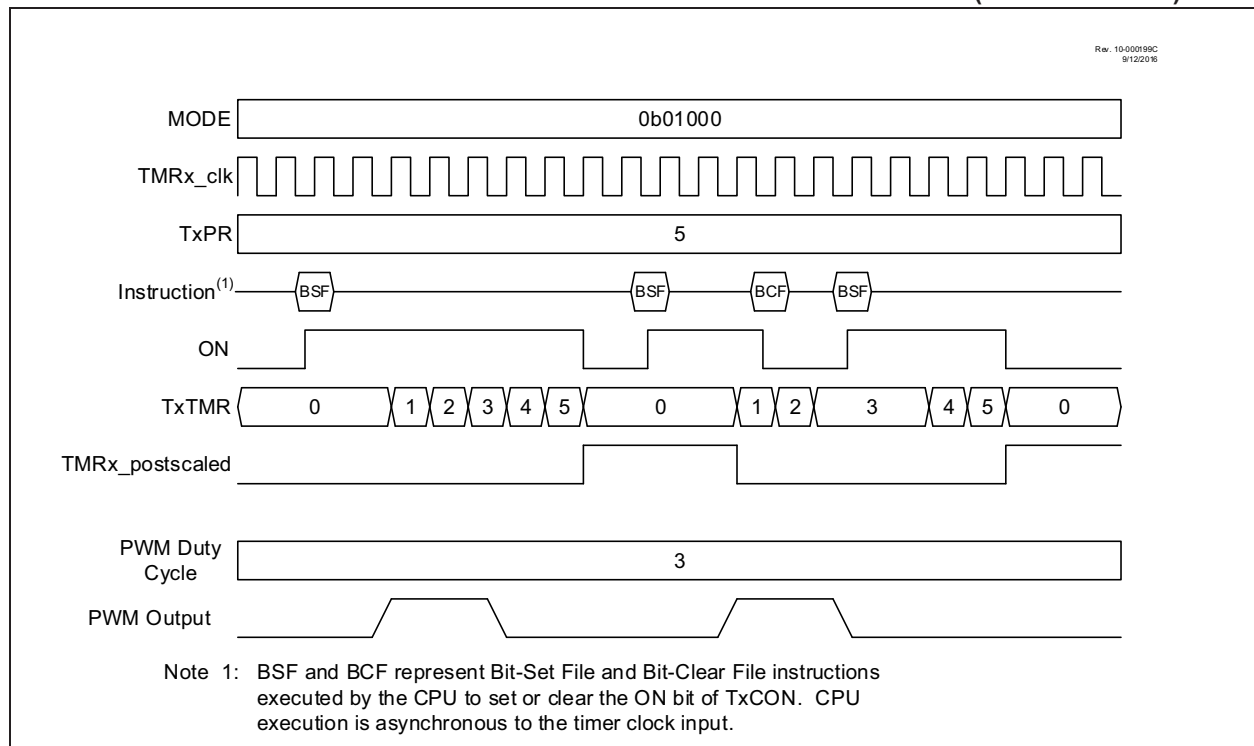
**Note:** If TRIGEN = 1 and BURSTMD = 1, the user should ensure that the trigger source is active for the Scanner operation to complete.

## 24.5.5 SOFTWARE START ONE-SHOT MODE

In One-Shot mode the timer resets and the ON bit is cleared when the timer value matches the T2PR period value. The ON bit must be set by software to start another timer cycle. Setting MODE<4:0> = 01000 selects One-Shot mode which is illustrated in Figure 24-8. In the example, ON is controlled by BSF and BCF instructions. In the first case, a BSF instruction sets ON and the counter runs to completion and clears ON. In the second case, a BSF instruction starts the cycle, BCF/BSF instructions turn the counter off and on during the cycle, and then it runs to completion.

When One-Shot mode is used in conjunction with the CCP PWM operation the PWM pulse drive starts concurrent with setting the ON bit. Clearing the ON bit while the PWM drive is active will extend the PWM drive. The PWM drive will terminate when the timer value matches the CCPRx pulse width value. The PWM drive will remain off until software sets the ON bit to start another cycle. If software clears the ON bit after the CCPRx match but before the T2PR match then the PWM drive will be extended by the length of time the ON bit remains cleared. Another timing cycle can only be initiated by setting the ON bit after it has been cleared by a T2PR period count match.

**FIGURE 24-8: SOFTWARE START ONE-SHOT MODE TIMING DIAGRAM (MODE = 01000)**





## 25.5 Register Definitions: CCP Control

Long bit name prefixes for the CCP peripherals are shown in Table 25-4. Refer to Section 1.4.2.2 “Long Bit Names” for more information.

TABLE 25-4:

Peripheral	Bit Name Prefix
CCP1	CCP1
CCP2	CCP2
CCP3	CCP3
CCP4	CCP4

REGISTER 25-1: CCPxCON: CCPx CONTROL REGISTER

R/W-0/0	U-0	R-x	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
EN	—	OUT	FMT	MODE<3:0>			
bit 7							bit 0

**Legend:**

R = Readable bit      W = Writable bit      U = Unimplemented bit, read as ‘0’  
 -n = Value at POR      ‘1’ = Bit is set      ‘0’ = Bit is cleared      x = Bit is unknown

bit 7      **EN:** CCP Module Enable bit  
           1 = CCP is enabled  
           0 = CCP is disabled

bit 6      **Unimplemented:** Read as ‘0’

bit 5      **OUT:** CCPx Output Data bit (read-only)

bit 4      **FMT:** CCPW (pulse-width) Alignment bit  
           **MODE = Capture mode:**  
           Unused  
           **MODE = Compare mode:**  
           Unused  
           **MODE = PWM mode:**  
           1 = Left-aligned format  
           0 = Right-aligned format

bit 3-0      **MODE<3:0>:** CCPx Mode Select bits

MODE	Operating Mode	Operation	Set CCPxIF
11xx	PWM	PWM operation	Yes
1011	Compare	Pulse output; clear TMR1 <sup>(2)</sup>	Yes
1010		Pulse output	Yes
1001		Clear output <sup>(1)</sup>	Yes
1000		Set output <sup>(1)</sup>	Yes
0111	Capture	Every 16th rising edge of CCPx input	Yes
0110		Every 4th rising edge of CCPx input	Yes
0101		Every rising edge of CCPx input	Yes
0100		Every falling edge of CCPx input	Yes
0011		Every edge of CCPx input	Yes
0010	Compare	Toggle output	Yes
0001		Toggle output; clear TMR1 <sup>(2)</sup>	Yes
0000	Disabled		—

**Note** 1: The set and clear operations of the Compare mode are reset by setting MODE = 4'b0000 or EN = 0.  
 2: When MODE = 0001 or 1011, then the timer associated with the CCP module is cleared. TMR1 is the default selection for the CCP module, so it is used for indication purpose only.

## REGISTER 27-13: SMT1CPWL: SMT CAPTURED PULSE WIDTH REGISTER – LOW BYTE

R-x/x	R-x/x	R-x/x	R-x/x	R-x/x	R-x/x	R-x/x	R-x/x
SMT1CPW<7:0>							
bit 7				bit 0			

### Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-0 **SMT1CPW<7:0>**: Significant bits of the SMT PW Latch – Low Byte

## REGISTER 27-14: SMT1CPWH: SMT CAPTURED PULSE WIDTH REGISTER – HIGH BYTE

R-x/x	R-x/x	R-x/x	R-x/x	R-x/x	R-x/x	R-x/x	R-x/x
SMT1CPW<15:8>							
bit 7				bit 0			

### Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-0 **SMT1CPW<15:8>**: Significant bits of the SMT PW Latch – High Byte

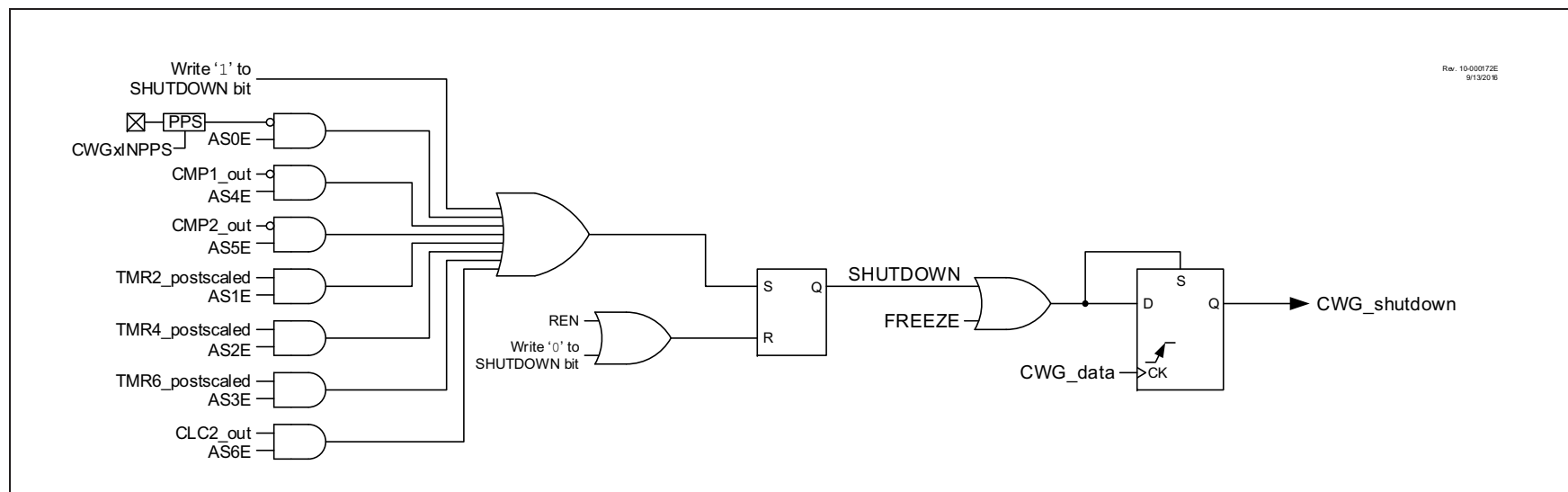
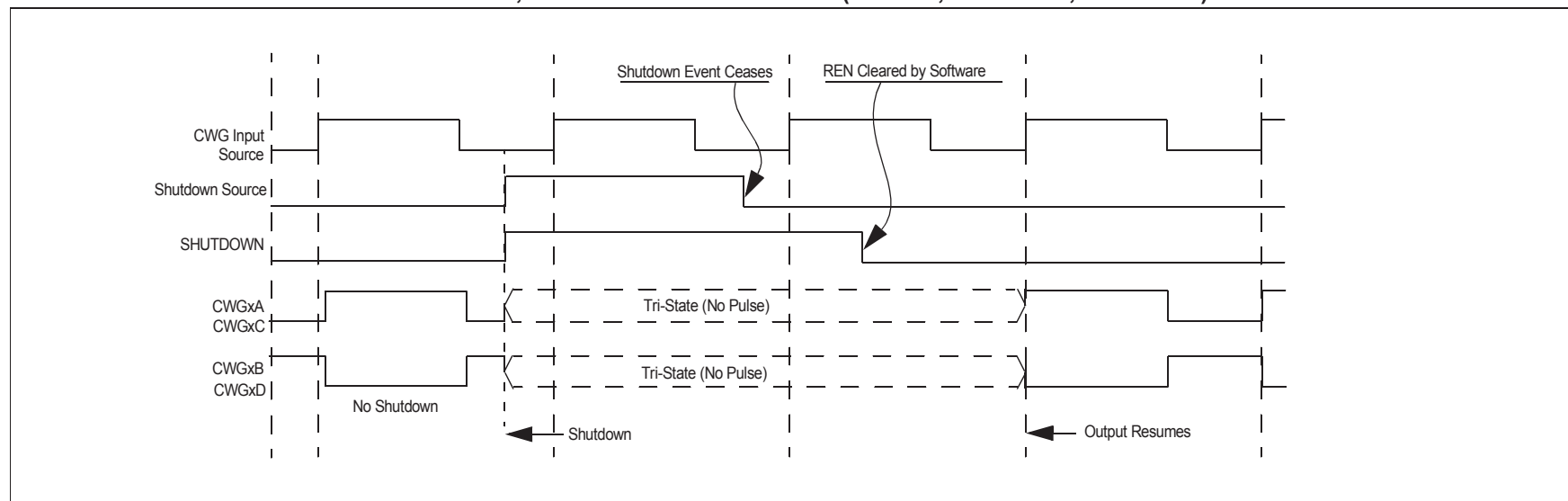
## REGISTER 27-15: SMT1CPWU: SMT CAPTURED PULSE WIDTH REGISTER – UPPER BYTE

R-x/x	R-x/x	R-x/x	R-x/x	R-x/x	R-x/x	R-x/x	R-x/x
SMT1CPW<23:16>							
bit 7				bit 0			

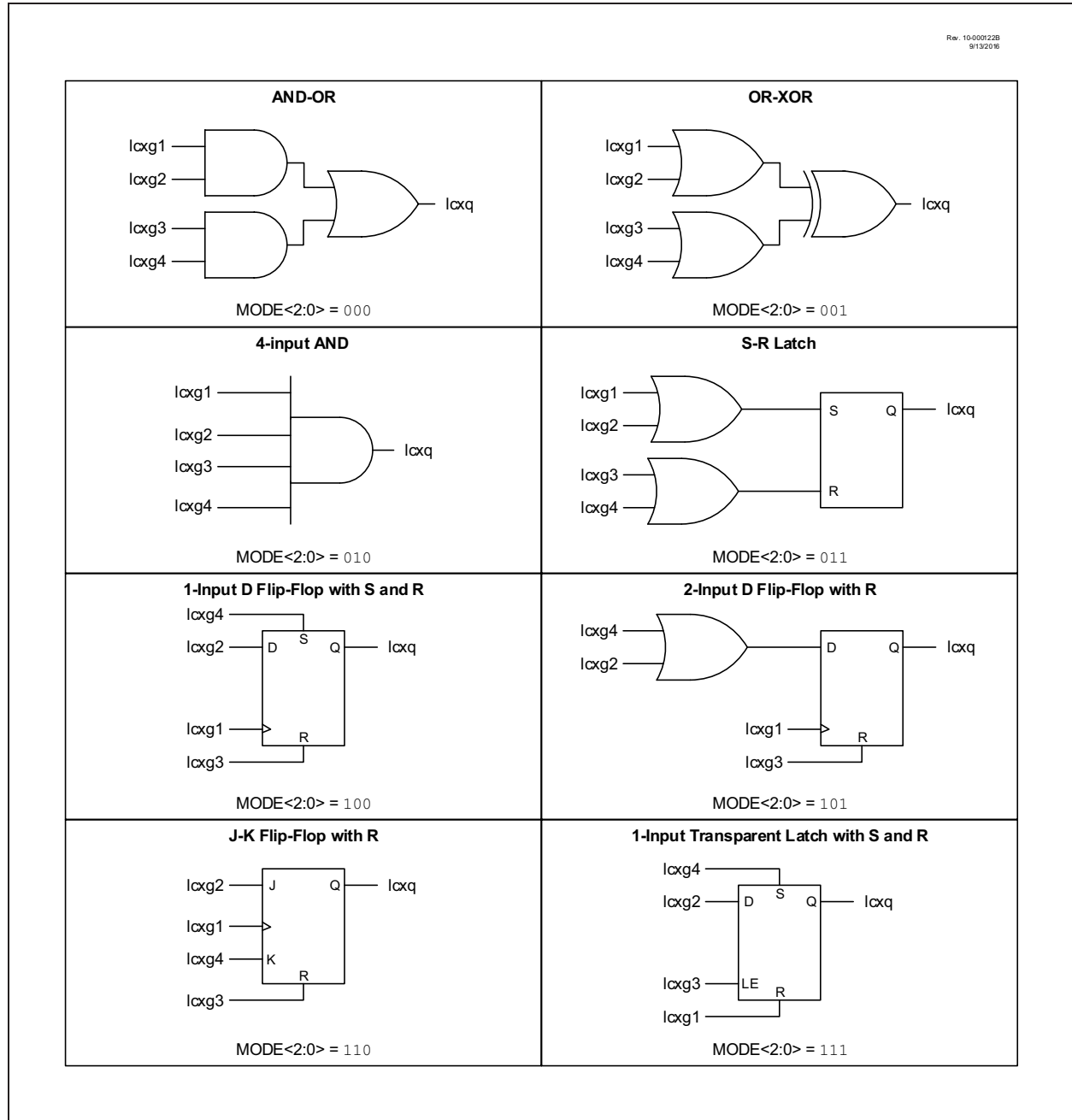
### Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

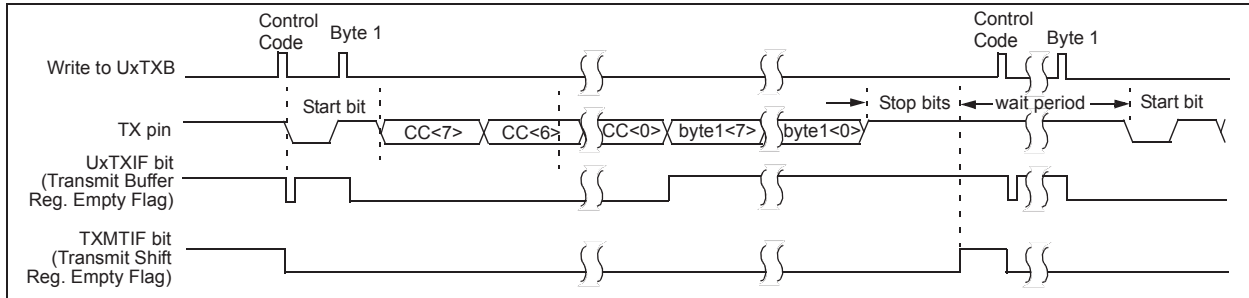
bit 7-0 **SMT1CPW<23:16>**: Significant bits of the SMT PW Latch – Upper Byte

**FIGURE 28-14: CWG SHUTDOWN BLOCK DIAGRAM****FIGURE 28-15: SHUTDOWN FUNCTIONALITY, AUTO-RESTART DISABLED (REN = 0, LSAC = 01, LSB D = 01)**

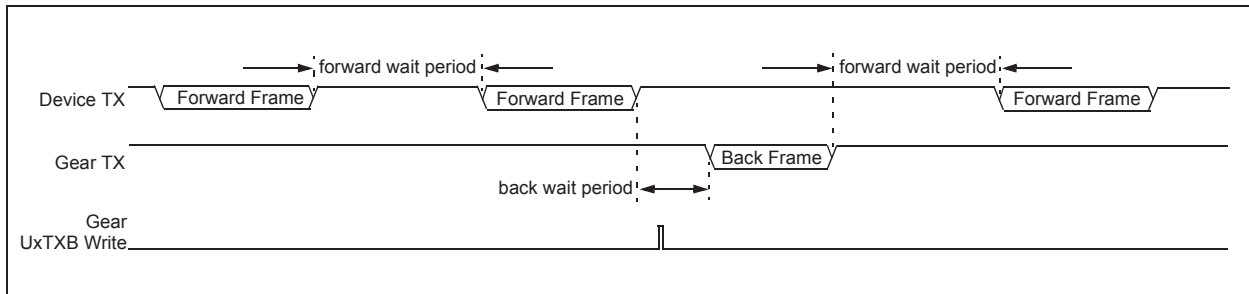
**FIGURE 29-3: PROGRAMMABLE LOGIC FUNCTIONS**



**FIGURE 33-8: DALI FRAME TIMING**



**FIGURE 33-9: DALI FORWARD/BACK FRAME TIMING**



## 33.7 General Purpose Manchester (UART1 only)

General purpose Manchester is a subset of the DALI mode. When the UxP1L register is cleared, there is no minimum wait time between frames. This allows full and half-duplex operation because writes to the UxTXB are not held waiting for a receive operation to complete.

General purpose Manchester operation maintains all other aspects of DALI mode such as:

- Single-pulse Start bit
- Most Significant bit first
- No stop periods between back-to-back bytes

General purpose Manchester mode is configured with the following settings:

- $MODE<3:0> = 1000$
- $TXEN = 1$
- $RXEN = 1$
- $UxP1 = 0h$
- $UxBRGH:L = \text{desired baud rate}$
- $TXPOL$  and  $RXPOL = \text{desired Idle state}$
- $STP = \text{desired number of stop periods}$
- $RxyPPS = \text{TX pin selection code}$
- TX pin TRIS control = 0
- $RXPPS = \text{RX pin selection code}$
- RX pin TRIS control = 1
- Input pin ANSEL bit = 0
- $ON = 1$

The Manchester bit stream timing is shown in [Figure 33-7](#).

## 33.8 Polarity

Receive and transmit polarity is user selectable and affects all modes of operation.

The idle level is programmable with the polarity control bits in the UxCON2 register. The control bits default to '0', which select a high idle level. The low level Idle state is selected by setting the control bit to '1'. TXPOL controls the TX idle level. RXPOL controls the RX idle level.

## 33.17.2 AUTO-BAUD OVERFLOW

During the course of automatic baud detection, the ABDOVF bit in the UxERRIR register will be set if the baud rate counter overflows before the fifth falling edge is detected on the RX pin. The ABDOVF bit indicates that the counter has exceeded the maximum count that can fit in the 16 bits of the UxBRGH:UxBRGL register pair. After the ABDOVF bit has been set, the state machine continues to search until the fifth falling edge is detected on the RX pin. Upon detecting the fifth falling RX edge, the hardware will set the ABDIF interrupt flag and clear the ABDEN bit in the UxCON0 register. The UxBRGH and UxBRGL register values retain their previous value. The ABDIF flag in the UxUIR register and ABDOVF flag in the UxERRIR register can be cleared by software directly. To generate an interrupt on an auto-baud overflow condition, all the following bits must be set:

- ABDOVE bit in the UxERRIE register
- UxEIE bit in the P1Ex register
- PIE and GIE bits in the INTCON register

To terminate the auto-baud process before the ABDIF flag is set, clear the ABDEN bit, then clear the ABDOVF bit in the UxERRIR register.

## 33.17.3 AUTO-WAKE-UP ON BREAK

During Sleep mode, all clocks to the UART are suspended. Because of this, the Baud Rate Generator is inactive and a proper character reception cannot be performed. The Auto-Wake-up feature allows the controller to wake-up due to activity on the RX line.

The Auto-Wake-up feature is enabled by setting both the WUE bit in the UxCON1 register and the UxIE bit in the P1Ex register. Once set, the normal receive sequence on RX is disabled, and the UART remains in an Idle state, monitoring for a wake-up event independent of the CPU mode. A wake-up event consists of a transition out of the Idle state on the RX line. (This coincides with the start of a Break or a wake-up signal character for the LIN protocol.)

The UART module generates a WUIF interrupt coincident with the wake-up event. The interrupt is generated synchronously to the Q clocks in normal CPU operating modes (Figure 33-13), and asynchronously, if the device is in Sleep mode (Figure 33-14). The interrupt condition is cleared by clearing the WUIF bit in the UxUIR register. To generate an interrupt on a wake-up event, all the following bits must be set:

- UxIE bit in the P1Ex register
- PIE and GIE bits in the INTCON register

The WUE bit is automatically cleared by the transition to the Idle state on the RX line at the end of the Break. This signals to the user that the Break event is over. At this point, the UART module is in Idle mode, waiting to receive the next character.

## 33.17.3.1 Special Considerations

### **Break Character**

To avoid character errors or character fragments during a wake-up event, the wake-up character must be all zeros.

When the wake-up is enabled, the function works independent of the low time on the data stream. If the WUE bit is set and a valid non-zero character is received, the low time from the Start bit to the first rising edge will be interpreted as the wake-up event. The remaining bits of the character will be received as a fragmented character and subsequent characters can result in framing or overrun errors.

Therefore, the initial character of the transmission must be all zeros. This must be eleven or more bit times, 13-bit times recommended for LIN bus, or any number of bit times for standard RS-232 devices.

### **Oscillator Start-up Time**

Oscillator start-up time must be considered, especially in applications using oscillators with longer start-up intervals (i.e., LP, XT or HS/PLL modes). The Sync Break (or wake-up signal) character must be of sufficient length, and be followed by a sufficient interval, to allow enough time for the selected oscillator to start and provide proper initialization of the UART.

### **WUE Bit**

To ensure that no actual data is lost, check the RXIDL bit to verify that a receive operation is not in process before setting the WUE bit. If a receive operation is not occurring, the WUE bit may then be set just prior to entering the Sleep mode.

## REGISTER 34-2: SPIxINTE: SPI INTERRUPT ENABLE REGISTER

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	U-0	R/W-0/0	R/W-0/0	U-0
SRMTIE	TCZIE	SOSIE	EOSIE	—	RXOIE	TXUIE	—
bit 7							bit 0

### Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

- bit 7 **SRMTIE**: Shift Register Empty Interrupt Enable bit  
 1 = Enables the Shift Register Empty Interrupt  
 0 = Disables the Shift Register Empty Interrupt
- bit 6 **TCZIE**: Transfer Counter is Zero Interrupt Enable bit  
 1 = Enables the Transfer Counter is Zero Interrupt  
 0 = Disables the Transfer Counter is Zero Interrupt
- bit 5 **SOSIE**: Start of Slave Select Interrupt Enable bit  
 1 = Enables the Start of Slave Select Interrupt  
 0 = Disables the Start of Slave Select Interrupt
- bit 4 **EOSIE**: End of Slave Select Interrupt Enable bit  
 1 = Enables the End of Slave Select Interrupt  
 0 = Disables the End of Slave Select Interrupt
- bit 3 **Unimplemented**: Read as '0'
- bit 2 **RXOIE**: Receiver Overflow Interrupt Enable bit  
 1 = Enables the Receiver Overflow Interrupt  
 0 = Disables the Receiver Overflow Interrupt
- bit 1 **TXUIE**: Transmitter Underflow Interrupt Enable bit  
 1 = Enables the Transmitter Underflow Interrupt  
 0 = Disables the Transmitter Underflow Interrupt
- bit 0 **Unimplemented**: Read as '0'

## REGISTER 34-3: SPIxTCNTL – SPI TRANSFER COUNTER LSB REGISTER

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
TCNT7	TCNT6	TCNT5	TCNT4	TCNT3	TCNT2	TCNT1	TCNT0
bit 7							bit 0

### Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

- bit 7-0 TCNT<7:0>  
**BMODE = 0:**  
 Bits 10-3 of the Transfer Counter, counting the total number of bits to transfer  
**BMODE = 1:**  
 Bits 7-0 of the Transfer Counter, counting the total number of bytes to transfer

**Note:** This register should not be written to while a transfer is in progress (BUSY bit of SPIxCON2 is set).

**TABLE 35-19: SUMMARY OF REGISTERS FOR I<sup>2</sup>C 8-BIT MACRO**

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on page
I2CxBTO	—	—	—	—	—	BTO<2:0>			584
I2CxCLK	—	—	—	—	—	CLK<2:0>			583
I2CxPIE	CNTIE	ACKTIE	—	WRIE	ADRIE	PCIE	RSCIE	SCIE	590
I2CxPIR	CNTIF	ACKTIF	—	WRIF	ADRIF	PCIF	RSCIF	SCIF	589
I2CxERR	—	BTOIF	BCLIF	NACKIF	—	BTOIE	BCLIE	NACKIE	587
I2CxSTAT0	BFRE	SMA	MMA	R	D	—	—	—	585
I2CxSTAT1	TXWE	—	TXBE	—	RXRE	CLRBF	—	RXBF	586
I2CxCON0	EN	RSEN	S	CSTR	MDR	MODE<2:0>			579
I2CxCON1	ACKCNT	ACKDT	ACKSTAT	ACKT	—	RXOV	TXU	CSD	581
I2CxCON2	ACNT	GCEN	FME	ADB	SDAHT<3:2>		BFRET<1:0>		582
I2CxADR0	ADR<7:0>								591
I2CxADR1	ADR<7:1>							—	592
I2CxADR2	ADR<7:0>								593
I2CxADR3	ADR<7:1>							—	594
I2CxADB0	ADB<7:0>								595
I2CxADB1	ADB<7:0>								596
I2xCNT	CNT<7:0>								588
I2CxRXB	RXB<7:0>								597
I2CXTXB	TXB<7:0>								597

**Legend:** — = unimplemented, read as '0'. Shaded cells are unused by the I<sup>2</sup>C module.



## REGISTER 38-13: ADCAP: ADC ADDITIONAL SAMPLE CAPACITOR SELECTION REGISTER

U-0	U-0	U-0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
—	—	—	ADCAP<4:0>				
bit 7			bit 0				

## BRA Unconditional Branch

Syntax:	BRA   n				
Operands:	-1024 ≤ n ≤ 1023				
Operation:	(PC) + 2 + 2n → PC				
Status Affected:	None				
Encoding:	<table><tr><td>1101</td><td>0nnn</td><td>nnnn</td><td>nnnn</td></tr></table>	1101	0nnn	nnnn	nnnn
1101	0nnn	nnnn	nnnn		
Description:	Add the 2's complement number '2n' to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC + 2 + 2n. This instruction is a 2-cycle instruction.				
Words:	1				
Cycles:	2				
Q Cycle Activity:					

Q1	Q2	Q3	Q4
Decode	Read literal 'n'	Process Data	Write to PC
No operation	No operation	No operation	No operation

**Example:**                    HERE                    BRA    Jump

Before Instruction  
PC = address (HERE)

After Instruction  
PC = address (Jump)

## BSF Bit Set f

Syntax:	BSF f, b {,a}				
Operands:	$0 \leq f \leq 255$ $0 \leq b \leq 7$ $a \in [0,1]$				
Operation:	$1 \rightarrow f \leftarrow b$				
Status Affected:	None				
Encoding:	<table border="1"><tr><td>1000</td><td>bbba</td><td>ffff</td><td>ffff</td></tr></table>	1000	bbba	ffff	ffff
1000	bbba	ffff	ffff		
Description:	<p>Bit 'b' in register 'f' is set.</p> <p>If 'a' is '0', the Access Bank is selected.</p> <p>If 'a' is '1', the BSR is used to select the GPR bank.</p> <p>If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever <math>f \leq 95</math> (5Fh). See <a href="#">Section 43.2.3 “Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode”</a> for details.</p>				
Words:	1				
Cycles:	1				
Q Cycle Activity:					

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write register 'f'

**Example:**                    BSF                    FLAG\_REG, 7, 1

Before Instruction  
FLAG\_REG = 0Ah

After Instruction  
FLAG\_REG = 8Ah

## RCALL

## Relative Call

Syntax:	RCALL    n				
Operands:	-1024 ≤ n ≤ 1023				
Operation:	(PC) + 2 → TOS, (PC) + 2 + 2n → PC				
Status Affected:	None				
Encoding:	<table><tr><td>1101</td><td>1nnn</td><td>nnnn</td><td>nnnn</td></tr></table>	1101	1nnn	nnnn	nnnn
1101	1nnn	nnnn	nnnn		
Description:	Subroutine call with a jump up to 1K from the current location. First, return address (PC + 2) is pushed onto the stack. Then, add the 2's complement number '2n' to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC + 2 + 2n. This instruction is a 2-cycle instruction.				
Words:	1				
Cycles:	2				

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal 'n' PUSH PC to stack	Process Data	Write to PC
No operation	No operation	No operation	No operation

**Example:** HERE RCALL Jump

Before Instruction

PC = Address (HERE)

After Instruction

PC = Address (Jump)

TOS = Address (HERE + 2)

## RESET

## Reset

Syntax:	RESET				
Operands:	None				
Operation:	Reset all registers and flags that are affected by a MCLR Reset.				
Status Affected:	All				
Encoding:	<table><tr><td>0000</td><td>0000</td><td>1111</td><td>1111</td></tr></table>	0000	0000	1111	1111
0000	0000	1111	1111		
Description:	This instruction provides a way to execute a MCLR Reset by software.				
Words:	1				
Cycles:	1				

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Start Reset	No operation	No operation

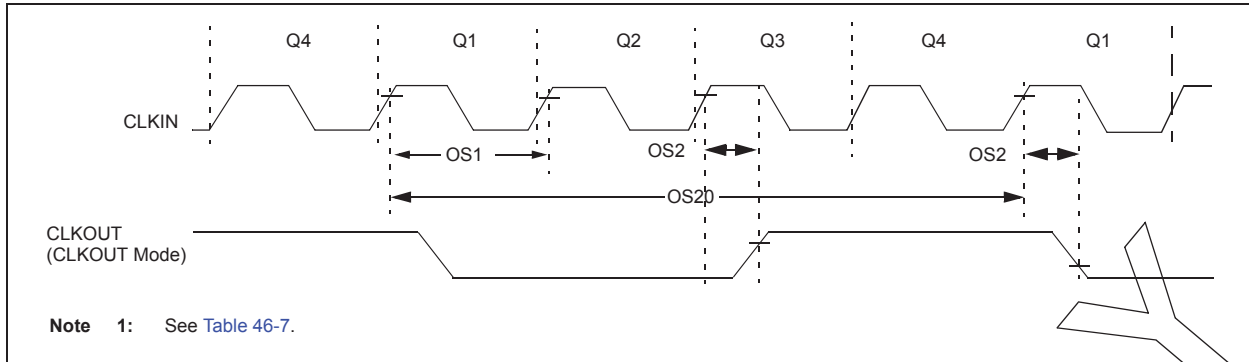
**Example:** RESET

After Instruction

Registers = Reset Value

Flags\* = Reset Value

**FIGURE 46-5: CLOCK TIMING**



**TABLE 46-7: EXTERNAL CLOCK/OSCILLATOR TIMING REQUIREMENTS**

Standard Operating Conditions (unless otherwise stated)							
Param No.	Sym.	Characteristic	Min.	Typ†	Max.	Units	Conditions
<b>ECL Oscillator</b>							
OS1	$F_{ECL}$	Clock Frequency	—	—	500	kHz	
OS2	$T_{ECL\_DC}$	Clock Duty Cycle	40	—	60	%	
<b>ECM Oscillator</b>							
OS3	$F_{ECM}$	Clock Frequency	—	—	4	MHz	
OS4	$T_{ECM\_DC}$	Clock Duty Cycle	40	—	60	%	
<b>ECH Oscillator</b>							
OS5	$F_{ECH}$	Clock Frequency	—	—	32	MHz	
OS6	$T_{ECH\_DC}$	Clock Duty Cycle	40	—	60	%	
<b>LP Oscillator</b>							
OS7	$F_{LP}$	Clock Frequency	—	—	100	kHz	Note 4
<b>XT Oscillator</b>							
OS8	$F_{XT}$	Clock Frequency	—	—	4	MHz	Note 4
<b>HS Oscillator</b>							
OS9	$F_{HS}$	Clock Frequency	—	—	20	MHz	Note 4
<b>Secondary Oscillator</b>							
OS10	$F_{SEC}$	Clock Frequency	32.4	32.768	33.1	kHz	
<b>System Oscillator</b>							
OS20	$F_{OSC}$	System Clock Frequency	—	—	64	MHz	(Note 2, Note 3)

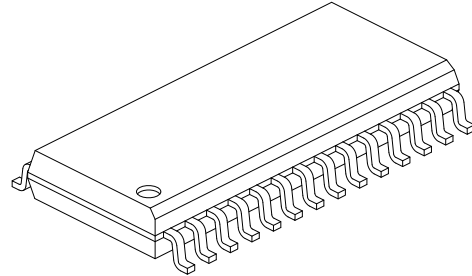
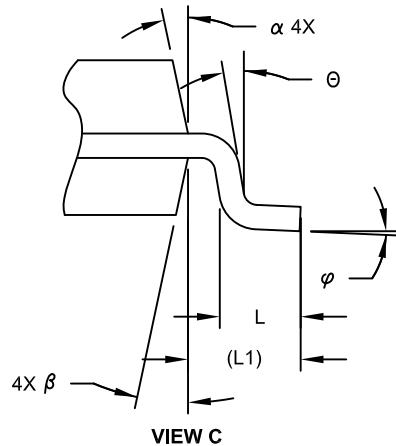
\* These parameters are characterized but not tested.

† Data in "Typ" column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

- Note 1:** Instruction cycle period (TCY) equals four times the input oscillator time base period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "min" values with an external clock applied to OSC1 pin. When an external clock input is used, the "max" cycle time limit is "DC" (no clock) for all devices.
- 2:** The system clock frequency ( $F_{OSC}$ ) is selected by the "main clock switch controls" as described in [Section 12.0 "Power-Saving Operation Modes"](#).
- 3:** The system clock frequency ( $F_{OSC}$ ) must meet the voltage requirements defined in the [Section 46.2 "Standard Operating Conditions"](#).
- 4:** LP, XT and HS oscillator modes require an appropriate crystal or resonator to be connected to the device. For clocking the device with the external square wave, one of the EC mode selections must be used.

## 28-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Dimension	Units	MILLIMETERS		
		MIN	NOM	MAX
Number of Pins	N	28		
Pitch	e	1.27 BSC		
Overall Height	A	-	-	2.65
Molded Package Thickness	A2	2.05	-	-
Standoff §	A1	0.10	-	0.30
Overall Width	E	10.30 BSC		
Molded Package Width	E1	7.50 BSC		
Overall Length	D	17.90 BSC		
Chamfer (Optional)	h	0.25	-	0.75
Foot Length	L	0.40	-	1.27
Footprint	L1	1.40 REF		
Lead Angle	θ	0°	-	-
Foot Angle	φ	0°	-	8°
Lead Thickness	c	0.18	-	0.33
Lead Width	b	0.31	-	0.51
Mold Draft Angle Top	α	5°	-	15°
Mold Draft Angle Bottom	β	5°	-	15°

### Notes:

- Pin 1 visual index feature may vary, but must be located within the hatched area.
- § Significant Characteristic
- Dimension D does not include mold flash, protrusions or gate burrs, which shall not exceed 0.15 mm per end. Dimension E1 does not include interlead flash or protrusion, which shall not exceed 0.25 mm per side.
- Dimensioning and tolerancing per ASME Y14.5M
  - BSC: Basic Dimension. Theoretically exact value shown without tolerances.
  - REF: Reference Dimension, usually without tolerance, for information purposes only.
- Datums A & B to be determined at Datum H.

Microchip Technology Drawing C04-052C Sheet 2 of 2